



# **AUTOMATED CHEMICAL SOLUTIONS**

**Chemicals and Controllers for PWB Fabrication**

## **Product Overview**

### **OXYshield AT-2320**

#### **Copper Anti-tarnish**

#### **Product Description**

OXYshield AT-2320 is a concentrated anti-tarnish designed to preserve cleaned copper surfaces and prevent re-oxidation prior to subsequent processing. OXYshield AT-2320 deposits a uniform triazole film that promotes excellent dry film adhesion.

#### **Physical Properties**

Specific gravity:	1.06
pH:	6-8
Appearance:	clear, light amber liquid
Flash point:	> 200 °F

#### **Operating Parameters**

Concentration:	0.3 – 3.0% v/v, 0.5% nominal
Temperature:	70 – 100 °F

#### **Storage**

Store in original containers above 40 °F.

#### **Safety**

Avoid contact with eyes, skin and clothing. Wear chemical handler's gloves, goggles and protective clothing when handling. Read and understand Material Safety Data Sheet before using this product.

#### **Notice**

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